

Audio IC Market By IC Type (Audio Amplifier, Audio DSP, Audio Codecs, and Microphone IC) and Application (Computer & Tablets, Phones, Headphones, Home Entertainment Systems, Automotive, Smart Home & IoT Devices, and Wearables): Global Opportunity Analysis and Industry Forecast, 2020–2027

https://marketpublishers.com/r/AE72A34F43B7EN.html

Date: April 2021

Pages: 307

Price: US\$ 6,168.00 (Single User License)

ID: AE72A34F43B7EN

Abstracts

The global audio IC market size was valued at \$27.72 Billion in 2019, and is projected to reach \$45.57 Billion by 2027, to register a CAGR of 7.09% from 2020 to 2027. Audio IC is an electronic device, which is used in audio processors, MEMS microphones, audio amplifiers, and subsystems. Various types of audio ICs include audio amplifiers, audio converters, audio DSPs, and audio processors. Audio amplifiers are used in sound systems such as home audio systems, musical instruments systems, loudspeakers, and sound reinforcement.

The purpose of an amplifier is to increase vibrations to the maximum extent of signals without affecting frequency or any wavelength, and help improve efficiency of a system. In addition, a digital sound processor (DSP) is a specialized microprocessor chip widely used in audio signal processing, telecommunications, digital image processing, radar, sonar and speech recognition systems, and consumer electronic devices such as mobile phones, disk drives, and high-definition television (HDTV) products.

Increase in adoption of consumer electronics devices and development of new energy efficient audio devices with enhanced user experience drives growth of the audio IC market. In addition, rise in penetration of wireless and smart infrastructure and surge in demand for Hi-Fi audio in commercial events fuel growth of the market. However,



increase in demand for audio SoCs and technical faults and issues associated with integration of audio devices is a major restraint for the global audio IC industry. Furthermore, rise in demand for on-board media entertainment systems and development of VR technology is expected to create opportunities for the audio IC industry.

The global audio IC market is segmented on the basis of IC type, application, and region. By IC type, the market is segmented into audio amplifier, audio DSP, audio codecs, and microphone IC. The application segment is divided into computer & tablets, phones, headphones, home entertainment systems, automotive, smart home & IoT devices, and wearables. Region wise, the audio IC market trends have been analyzed across North America, Europe, Asia-Pacific, and LAMEA.

The key players operating in the market include as Analog Devices, Inc., Cirrus Logic, NXP Semiconductors, STMicroelectronics, Maxim Integrated, ROHM CO., LTD., Texas Instruments, ON Semiconductors, Toshiba Corporation, and Infineon. These key players have adopted various strategies, such as product portfolio expansion, mergers & acquisitions, agreements, geographical expansion, and collaborations, to increase their market penetration and strengthen their foothold in the industry.

Audio IC Market Key Segments

By IC Type

Audio Amplifier

Audio DSP

Audio Codecs

Microphone IC

By Application

Computer & Tablets

Phones



Headphones

Home Entertainment Systems		
Automotive		
Smart Home & IoT devices		
Wearables		
Others		
By Region		
North America		
U.S.		
Canada		
Mexico		
Europe		
Sweden		
France		
Germany		
Russia		
Rest of Europe		
Asia-Pacific		
China		



Japan

	India	
	Rest of Asia-Pacific	
LAMEA		
	Latin America	
	Middle East	
	Africa	
Key Market	Players	
Ana	log Devices Inc.	
Cirro	us Logic	
NXF	Semiconductors	
STM	licroelectronics	
Max	im Integrated	
ROH	HM CO. LTD.	
Texa	as Instruments	
ON	Semiconductors	
Tosl	niba Corporation	
Infin	eon	



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